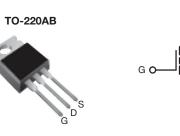


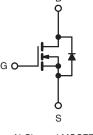
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	800				
R _{DS(on)} (Ω)	V _{GS} = 10 V 6.5				
Q _g (Max.) (nC)	38				
Q _{gs} (nC)	5.0				
Q _{gd} (nC)	21				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBE20PbF
	SiHFBE20-E3
SnPb	IRFBE20
	SiHFBE20

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	800	V
Gate-Source Voltage			V _{GS}	± 20	v
		$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		1.8	
Continuous Drain Current	V _{GS} at 10 V	$T_C = 100 \ ^\circ C$	I _D	1.2	А
Pulsed Drain Current ^a			I _{DM}	7.2	
Linear Derating Factor				0.43	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	180	mJ
Repetitive Avalanche Current ^a			I _{AR}	1.8	А
Repetitive Avalanche Energy ^a			E _{AR}	5.4	mJ
Maximum Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			PD	54	W
Peak Diode Recovery dV/dt ^c			dV/dt	2.0	V/ns
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	℃
Soldering Recommendations (Peak Temperature) for 10 s				300 ^d	C
Mounting Torque	6.20.0*	0.00		10	lbf ∙ in
Mounting Torque	6-32 or M3 screw			1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 104 mH, R_g = 25 Ω , I_{AS} = 1.8 A (see fig. 12).

c. $I_{SD} \le 1.8$ A, dI/dt ≤ 80 A/µs, $V_{DD} \le 600$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.3	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	800	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference t	to 25 °C, I _D = 1 mA	-	0.98	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V	_{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	_S = ± 20 V	-	-	± 100	nA
Zoro Goto Voltago Droin Curront	I _{DSS}	V _{DS} = 8	$V_{DS} = 800 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	100	
Zero Gate Voltage Drain Current		V _{DS} = 640 V, V	/ _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 1.1 A ^b	-	-	6.5	Ω
Forward Transconductance	g _{fs}	V _{DS} = 10	00 V, I _D = 1.1 A ^b	0.80	-	-	S
Dynamic							
Input Capacitance	C _{iss}	V	$G_{GS} = 0 V,$	-	530	-	pF
Output Capacitance	C _{oss}	V	$_{\rm DS} = 25 {\rm V},$	-	150	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5	-	90	-	
Total Gate Charge	Qg		$V_{GS} = 10 V$ $I_D = 1.8 A, V_{DS} = 400 V,$ see fig. 6 and 13 ^b		-	38	nC
Gate-Source Charge	Q_gs	$V_{GS} = 10 \text{ V}$			-	5.0	
Gate-Drain Charge	Q _{gd}			-	-	21	1
Turn-On Delay Time	t _{d(on)}	V_{DD} = 400 V, I_D = 1.8 A, R_g = 18 Ω , R_D = 230 Ω , see fig. 10 ^b		-	8.2	-	- ns
Rise Time	t _r			-	17	-	
Turn-Off Delay Time	t _{d(off)}			-	58	-	
Fall Time	t _f			-	27	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	24
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1.8	Α
Pulsed Diode Forward Current ^a	I _{SM}			-	-	7.2	
Body Diode Voltage	V_{SD}	$T_J = 25 \text{ °C}, I_S = 1.8 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.4	V
Body Diode Reverse Recovery Time	t _{rr}	- $T_J = 25 \text{ °C}, I_F = 1.8 \text{ A}, dI/dt = 100 \text{ A/}\mu\text{s}^b$		-	380	570	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.94	1.4	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)			L _D)		

Notes

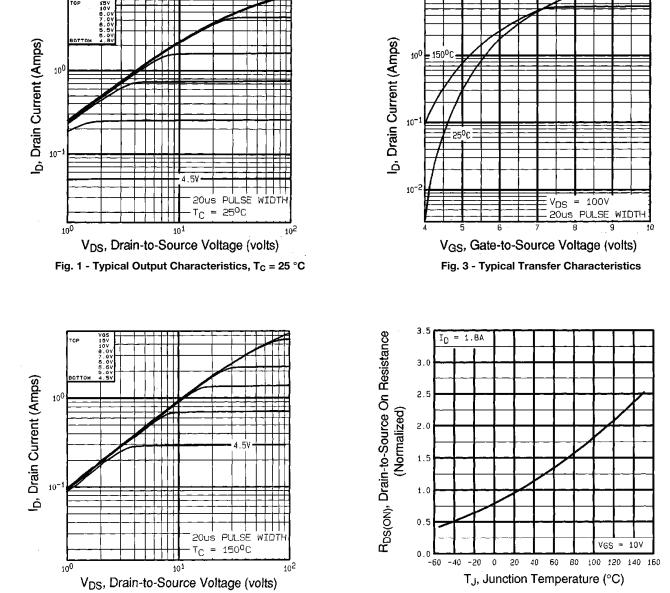
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

Fig. 4 - Normalized On-Resistance vs. Temperature

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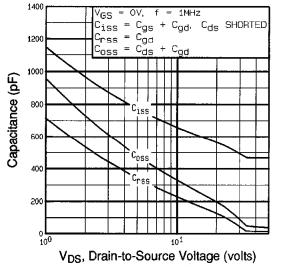


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

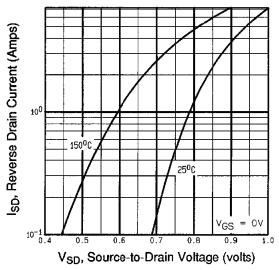


Fig. 7 - Typical Source-Drain Diode Forward Voltage

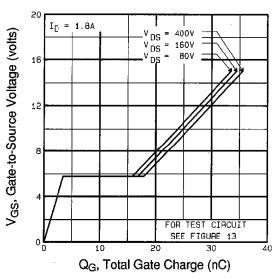
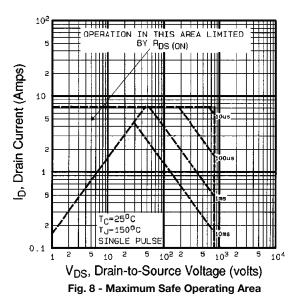


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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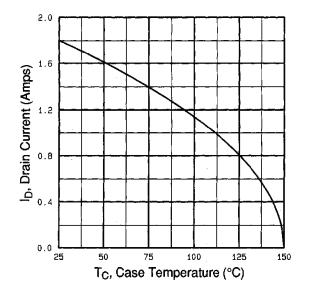


Fig. 9 - Maximum Drain Current vs. Case Temperature

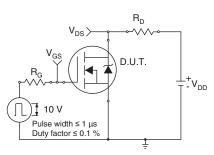


Fig. 10a - Switching Time Test Circuit

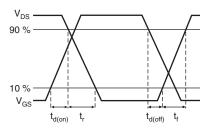


Fig. 10b - Switching Time Waveforms

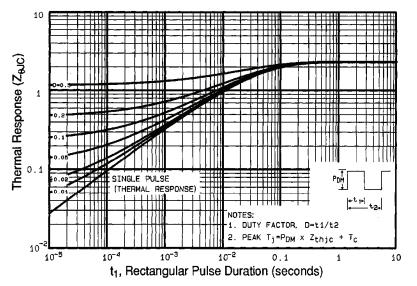


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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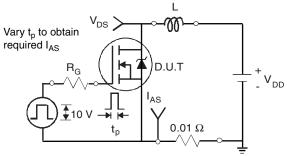


Fig. 12a - Unclamped Inductive Test Circuit

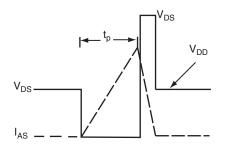


Fig. 12b - Unclamped Inductive Waveforms

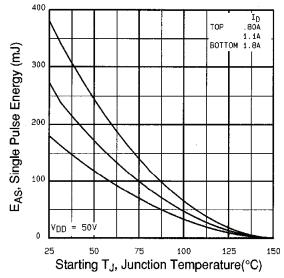


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

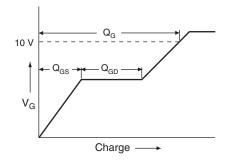


Fig. 13a - Basic Gate Charge Waveform

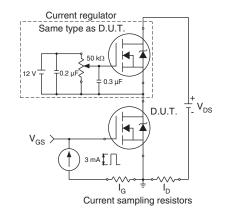
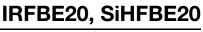


Fig. 13b - Gate Charge Test Circuit

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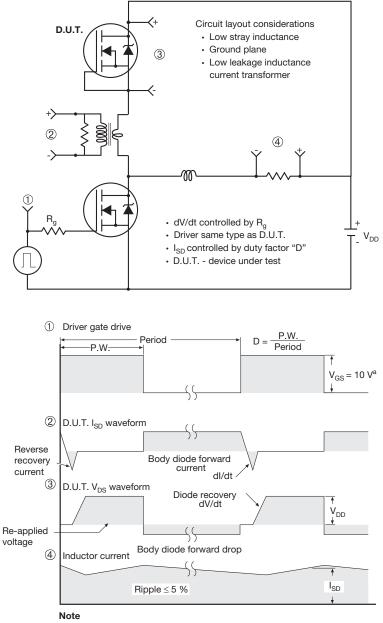
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Peak Diode Recovery dV/dt Test Circuit

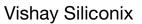


a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

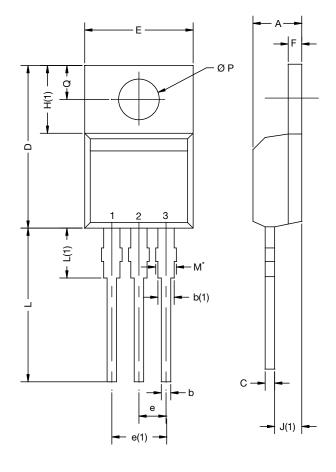
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TO-220-1



DIM.	MILLIN	MILLIMETERS		INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi	'an	
		IRF 9510 744K AB		

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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